

## GENERAL DESCRIPTION

This chapter gives an overview of the 260-pin SO DDR4 Dual-In-Line memory modules product family and describes its main characteristics.

## FEATURES

- VDD=VDDQ=1.2V +/- 0.06V
  - VPP = 2.5V, -125mV/+250mV
  - On-die, internal, adjustable VREFDQ generation
  - 1.2V pseudo open-drain I/O
  - TC of 0°C to 85°C
  - 64ms, 8192-cycle refresh at 0°C to 85°C
  - JEDEC standard 78ball FBGA※
- Above Picture is for reference only!
- Programmable data strobe preambles
  - Data strobe preamble training
  - Command/Address latency (CAL)
  - Multipurpose register READ and WRITE capability
  - Write and read leveling
  - Self refresh mode
  - Low-power auto self refresh (LPASR)
  - Temperature controlled refresh (TCR)
  - Fine granularity refresh
  - Self refresh abort
  - Maximum power saving
  - Output driver calibration
  - Nominal, park, and dynamic on-die termination (ODT)
  - Data bus inversion (DBI) for data bus
  - Command/Address (CA) parity
  - Databus write cyclic redundancy check (CRC)
  - Per-DRAM addressability
  - Post package repair (PPR) and soft post package repair (sPPR) modes • JEDEC JESD-79-4 compliant

## Information for Compliant Products

Product Type	Compliance Code	Description
IND-ID4N21SP16X	16GB DDR4-2133 15/15/15	1 Ran, Non-ECC
IND-ID4N24SP16X	16GB DDR4-2400 17/17/17	1 Ran, Non-ECC
IND-ID4N26SP16X	16GB DDR4-2666 19/19/19	1 Ran, Non-ECC
IND-ID4N29SP16X	16GB DDR4-2933 21/21/21	1 Ran, Non-ECC
IND-ID4N32SP16X	16GB DDR4-3200 22/22/22	1 Ran, Non-ECC

## Pinout

260-Pin DDR4 SODIMM Front								260-Pin DDR4 SODIMM Back							
Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol	Pin	Symbol		
1	V <sub>SS</sub>	67	DQ29	133	A1	199	DM5_n/ DBI5_n	2	V <sub>SS</sub>	68	V <sub>SS</sub>	134	EVENT_n, NF	200	DQS5_t
3	DQ5	69	V <sub>SS</sub>	135	V <sub>DD</sub>	201	V <sub>SS</sub>	4	DQ4	70	DQ24	136	V <sub>DD</sub>	202	V <sub>SS</sub>
5	V <sub>SS</sub>	71	DQ25	137	CK0_t	203	DQ46	6	V <sub>SS</sub>	72	V <sub>SS</sub>	138	CK1_t/NF	204	DQ47
7	DQ1	73	V <sub>SS</sub>	139	CK0_c	205	V <sub>SS</sub>	8	DQ0	74	DQS3_c	140	CK1_c/NF	206	V <sub>SS</sub>
9	V <sub>SS</sub>	75	DM3_n/ DBI3_n	141	V <sub>DD</sub>	207	DQ42	10	V <sub>SS</sub>	76	DQS3_t	142	V <sub>DD</sub>	208	DQ43
11	DQS0_c	77	V <sub>SS</sub>	143	PARITY	209	V <sub>SS</sub>	12	DM0_n/ DBI0_n	78	V <sub>SS</sub>	144	A0	210	V <sub>SS</sub>
13	DQS0_t	79	DQ30	145	BA1	211	DQ52	14	V <sub>SS</sub>	80	DQ31	146	A10/AP	212	DQ53
15	V <sub>SS</sub>	81	V <sub>SS</sub>	147	V <sub>DD</sub>	213	V <sub>SS</sub>	16	DQ6	82	V <sub>SS</sub>	148	V <sub>DD</sub>	214	V <sub>SS</sub>
17	DQ7	83	DQ26	149	CS0_n	215	DQ49	18	V <sub>SS</sub>	84	DQ27	150	BA0	216	DQ48
19	V <sub>SS</sub>	85	V <sub>SS</sub>	151	WE_n/ A14	217	V <sub>SS</sub>	20	DQ2	86	V <sub>SS</sub>	152	RAS_n/ A16	218	V <sub>SS</sub>
21	DQ3	87	CB5/NC	153	V <sub>DD</sub>	219	DQS6_c	22	V <sub>SS</sub>	88	CB4/NC	154	V <sub>DD</sub>	220	DM6_n/ DBI6_n
23	V <sub>SS</sub>	89	V <sub>SS</sub>	155	ODT0	221	DQS6_t	24	DQ12	90	V <sub>SS</sub>	156	CAS_n/ A15	222	V <sub>SS</sub>
25	DQ13	91	CB1/NC	157	CS1_n	223	V <sub>SS</sub>	26	V <sub>SS</sub>	92	CB0/NC	158	A13	224	DQ54
27	V <sub>SS</sub>	93	V <sub>SS</sub>	159	V <sub>DD</sub>	225	DQ55	28	DQ8	94	V <sub>SS</sub>	160	V <sub>DD</sub>	226	V <sub>SS</sub>
29	DQ9	95	DQS8_c	161	ODT1	227	V <sub>SS</sub>	30	V <sub>SS</sub>	96	DM8_n/ DBI_n/NC	162	C0/ CS2_n/NC	228	DQ50
31	V <sub>SS</sub>	97	DQS8_t	163	V <sub>DD</sub>	229	DQ51	32	DQS1_c	98	V <sub>SS</sub>	164	V <sub>REFCA</sub>	230	V <sub>SS</sub>
33	DM1_n/ DBI_n	99	V <sub>SS</sub>	165	C1,CS3_n, NC	231	V <sub>SS</sub>	34	DQS1_t	100	CB6/NC	166	SA2	232	DQ60
35	V <sub>SS</sub>	101	CB2/NC	167	V <sub>SS</sub>	233	DQ61	36	V <sub>SS</sub>	102	V <sub>SS</sub>	168	V <sub>SS</sub>	234	V <sub>SS</sub>
37	DQ15	103	V <sub>SS</sub>	169	DQ37	235	V <sub>SS</sub>	38	DQ14	104	CB7/NC	170	DQ36	236	DQ57
39	V <sub>SS</sub>	105	CB3/NC	171	V <sub>SS</sub>	237	DQ56	40	V <sub>SS</sub>	106	V <sub>SS</sub>	172	V <sub>SS</sub>	238	V <sub>SS</sub>
41	DQ10	107	V <sub>SS</sub>	173	DQ33	239	V <sub>SS</sub>	42	DQ11	108	RESET_n	174	DQ32	240	DQS7_c
43	V <sub>SS</sub>	109	CKE0	175	V <sub>SS</sub>	241	DM7_n/ DBI7_n	44	V <sub>SS</sub>	110	CKE1	176	V <sub>SS</sub>	242	DQS7_t
45	DQ21	111	V <sub>DD</sub>	177	DQS4_c	243	V <sub>SS</sub>	46	DQ20	112	V <sub>DD</sub>	178	DM4_n/ DBI4_n	244	V <sub>SS</sub>
47	V <sub>SS</sub>	113	BG1	179	DQS4_t	245	DQ62	48	V <sub>SS</sub>	114	ACT_n	180	V <sub>SS</sub>	246	DQ63
49	DQ17	115	BG0	181	V <sub>SS</sub>	247	V <sub>SS</sub>	50	DQ16	116	ALERT_n	182	DQ39	248	V <sub>SS</sub>
51	V <sub>SS</sub>	117	V <sub>DD</sub>	183	DQ38	249	DQ58	52	V <sub>SS</sub>	118	V <sub>DD</sub>	184	V <sub>SS</sub>	250	DQ59
53	DQS2_c	119	A12	185	V <sub>SS</sub>	251	V <sub>SS</sub>	54	DM2_n/ DBI2_n	120	A11	186	DQ35	252	V <sub>SS</sub>
55	DQS2_t	121	A9	187	DQ34	253	SCL	56	V <sub>SS</sub>	122	A7	188	V <sub>SS</sub>	254	SDA
57	V <sub>SS</sub>	123	V <sub>DD</sub>	189	V <sub>SS</sub>	255	V <sub>DDSPS</sub>	58	DQ22	124	V <sub>DD</sub>	190	DQ45	256	SA0
59	DQ23	125	A8	191	DQ44	257	V <sub>pp</sub>	60	V <sub>SS</sub>	126	A5	192	V <sub>SS</sub>	258	V <sub>TT</sub>
61	V <sub>SS</sub>	127	A6	193	V <sub>SS</sub>	259	V <sub>pp</sub>	62	DQ18	128	A4	194	DQ41	260	SA1
63	DQ19	129	V <sub>DD</sub>	195	DQ40	—	—	64	V <sub>SS</sub>	130	V <sub>DD</sub>	196	V <sub>SS</sub>	—	—
65	V <sub>SS</sub>	131	A3	197	V <sub>SS</sub>	—	—	66	DQ28	132	A2	198	DQS5_c	—	—

## Pin Descriptions

Pin Name	Description	Pin Name	Description
A0-A17 <sup>1</sup>	SDRAM address bus	SCL	I <sup>2</sup> C serial bus clock for SPD-TSE
BA0, BA1	SDRAM bank select	SDA	I <sup>2</sup> C serial bus line for SPD-TSE
BG0, BG1	SDRAM bank group select	SA0-SA2	I <sup>2</sup> C slave address select for SPD-TSE
RAS <sub>n</sub> <sup>2</sup>	SDRAM row address strobe	PARITY	SDRAM parity input
CAS <sub>n</sub> <sup>3</sup>	SDRAM column address strobe	VDD	SDRAM I/O and core power supply
WE <sub>n</sub> <sup>4</sup>	SDRAM write enable	C0, C1, C2	Chip ID lines
CS0 <sub>n</sub> , CS1 <sub>n</sub>	DIMM Rank Select Lines	12V	Optional power Supply on socket but not used on UDIMM
CKE0, CEK1	SDRAM clock enable lines input	VREFCA	SDRAM command/address reference supply
ODT0, ODT1	SDRAM on-die termination control lines input	VSS	Power supply return (ground)
ACT <sub>n</sub>	SDRAM activate	VDDSPD	Serial SPD-TSE positive power supply
DQ0-DQ63	DIMM memory data bus	ALERT <sub>n</sub>	SDRAM ALERT <sub>n</sub> output
CB0-CB7	DIMM ECC check bits	VPP	SDRAM Supply
TDQS0 <sub>t</sub> -TDQS8 <sub>t</sub> TDQS0 <sub>c</sub> -TDQS8 <sub>c</sub>	Dummy loads for mixed populations of x4 based and x8 based RDIMMs. Not used on UDIMMs.		
DQS0 <sub>t</sub> -DQS8 <sub>t</sub>	SDRAM data strobes (positive line of differential pair)		
DQS0 <sub>c</sub> -DQS8 <sub>c</sub>	SDRAM data strobes (negative line of differential pair)	RESET <sub>n</sub>	Set DRAMs to a Known State
DM0 <sub>n</sub> -DM8 <sub>n</sub> , DBI0 <sub>n</sub> -DBI8 <sub>n</sub>	SDRAM data masks/data bus inersion (x8-based x72 DIMMs)	EVENT <sub>n</sub>	SPD signals a thermal event has occurred
CK0 <sub>t</sub> , CK1 <sub>t</sub>	SDRAM clock (positive line of differen-tial pair)	VTT	SDRAM I/O termination supply
CK0 <sub>c</sub> , CK1 <sub>c</sub>	SDRAM clock (positive line of differen-tial pair)	RFU	Reserved for future use

1. Address A17 is not valid for x8 and x16 based SDRAMs. For UDIMMs, this connection pin is NC.
2. RAS<sub>n</sub> is a multiplexed function with A16.
3. CAS<sub>n</sub> is a multiplexed function with A15.
4. WE<sub>n</sub> is a multiplexed function with A14.

## Operating Temperature Range

Symbol	Parameter	Rating	Units	Notes
$T_{OPR}$	Normal Operating Temperature Range	0 ~ 85	°C	1,2
	Extended Temperature Range (Optional)	85 ~ 95	°C	1,3

Notes 1. Operating Temperature  $T_{OPER}$  is the case surface temperature on the center / top side of the DRAM. For measurement conditions, please refer to the JEDEC document JESD51-2.

Notes 2. The Normal Temperature Range specifies the temperatures where all DRAM specifications will be supported. During operation, the DRAM case temperature must be maintained between 0 to 85 °C under all operating conditions.

Notes 3. Some applications require operation of the DRAM in the Extended Temperature Range between 85 °C and 95 °C case temperature. Full specifications are supported in this range, but the following additional conditions apply:

- a. Refresh commands must be doubled in frequency, therefore reducing the Refresh interval  $t_{REFI}$  to 3.9  $\mu$ s. It is also possible to specify a component with 1X refresh ( $t_{REFI}$  to 7.8 $\mu$ s) in the Extended Temperature Range. Please refer to DIMM SPD for option availability.
- b. If Self-Refresh operation is required in the Extended Temperature Range, then it is mandatory to either use the Manual Self-Refresh mode with Extended Temperature Range capability (MR2 A6 = 0b and MR2 A7 = 1b) or enable the optional Auto Self-Refresh mode (MR2 A6 = 1b and MR2 A7 = 0b).

Follow JEDEC specification.

